SCHOTTKY DIODE ARRAY

SDA₃₂

ISSUE 2 – JANUARY 1998

DEVICE DESCRIPTION

The SDA32 Schottky Barrier Diode Array is designed to reduce reflection noise on high speed parallel data lines.

The device helps suppress transients caused by transmission line reflections, cross talk and switching noise.

The SDA32 consists of an array of 16 high speed Schottky diode pairs suitable for clamping to Vcc and / or Gnd.

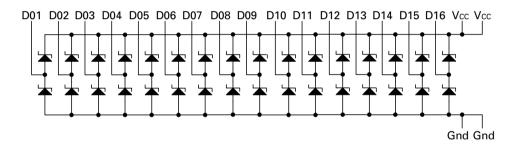
FEATURES

- Reduced reflection noise
- Repetitive peak forward current -200mA
- 16 diode pairs
- SO20 and DIL20 packages

APPLICATIONS

- Termination of data lines
- Protection of memory devices

SCHEMATIC DIAGRAM



SDA₃₂

ABSOLUTE MAXIMUM RATING (at Tamb= 25°C unless otherwise stated)* 7V

Steady-State Reverse Voltage

Continuous Forward Current 50mA(1)

170mA(2)

Repetitive Peak Forward Current (3) 200mA(1)

1A(2)

625mW Continuous Total Power Dissipation (4)

(SO and DIL packages)

Operating Free-air Temperature Range 0 to 70°C Storage Temperature Range -65 to 150°C

- (1) Any D terminal from Gnd or to V_{CC}
- (2) Total through all Gnd or Vcc terminals
- (3) These values apply for $t_W=100\mu s$, duty cycle $\leq 20\%$
- (4) For operation above 25°C, derate linearly at the rate of 6.25mW/°C

ELECTRICAL CHARACTERISTICS (at T_{amb}=25°C unless otherwise stated)

Single-Diode Operation

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Static Forward Voltage	V _F		0.85	1.05	٧	To V _{CC} , I _F =18mA
			1.05	1.3	V	To V _{CC} , I _F =50mA
			0.75	0.95	V	From Gnd, I _F =18mA
			0.95	1.2	V	From Gnd, I _F =50mA
Peak Forward Voltage	V_{FM}		1.45		V	I _F =200mA
Static Reverse Current	I _R			6	μΑ	To V _{CC} ,V _R =7V
				5	μΑ	From Gnd, V _R =7V
Total Capacitance	C _T		6	16	pF	V _R =0, f=1MHz
			4	6	pF	V _R =2V, f=1MHz

Note:

(5) Test conditions and limits apply separately to each of the diodes. The diodes not under test are open circuited during the measurement of these characteristics.

Multiple-Diode Operation

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Internal Crosstalk Current	I _X		8.0	2	mA	Total I _F =1A (6)
			0.02	0.2	mA	Total I _F =198mA (6)

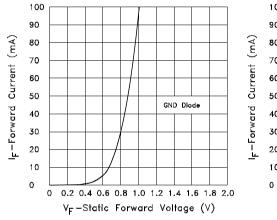
^{*} Stresses beyond those listed above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under the recommended operating conditions is not implied. Exposure to absolute maximum rated conditions for extended periods of time may affect device reliability.

⁽⁶⁾ I_X is measured under the following conditions with one diode static, and all others switching. Switching diodes: $t_W=100us$, duty cycle=0.2; static diode; $V_R=5V$. The static diode input current is the internal crosstalk current I_X .

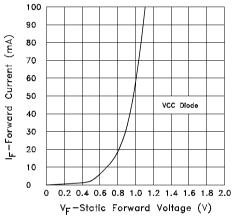
SWITCHING CHARACTERISTICS (over operating free-air temperature range)

PARAMETER	SYMBOL	MIN.	TYP.	MAX	UNIT	CONDITIONS
Reverse Recovery Time	t _{rr}		8	16	ns	$I_{F}=10mA$ $I_{R(REC)}=1mA$ $I_{RM(REC)}=10mA$ $R_{L}=100\Omega$

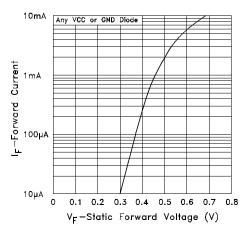
TYPICAL CHARACTERISTICS



I_F vs V_F Characteristic



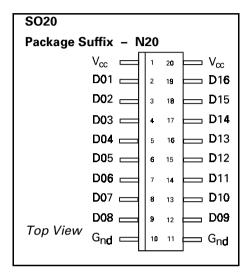
I_F vs V_F Characteristic

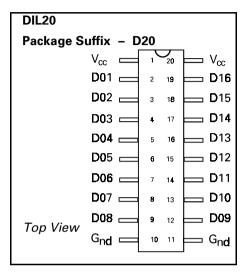


Low I_F vs V_F Characteristic

SDA32

CONNECTION DIAGRAMS





ORDERING INFORMATION

Part Number	Package	Part Mark		
SDA32N20	SO20	SDA32		
SDA32D20	DIL20	SDA32		